

**PATENT**

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

**In re Application of:**

Hiatt et al.

**Serial No.:** 10/705,409

**Filed:** November 10, 2003

**For:** SUBSTRATE SUPPORTS FOR USE  
WITH PROGRAMMABLE MATERIAL  
CONSOLIDATION APPARATUS AND  
SYSTEMS

**VIA ELECTRONIC FILING  
MAY 10, 2007**

**Confirmation No.:** 3302

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**Group Art Unit:** 2125

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February 12, 2007

**FEE ADDRESSEE FOR RECEIPT OF PTO NOTICES  
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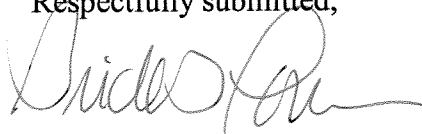
1. This letter is to specify that the FEE ADDRESSEE for this patent is:

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2. The Customer Number for the Fee Addressee is **26809**.
3. Any prior FEE ADDRESSEE for this patent is hereby revoked.
4. It is certified that the person whose signature appears below has the authority to change the FEE ADDRESSEE for this patent.

Respectfully submitted,



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